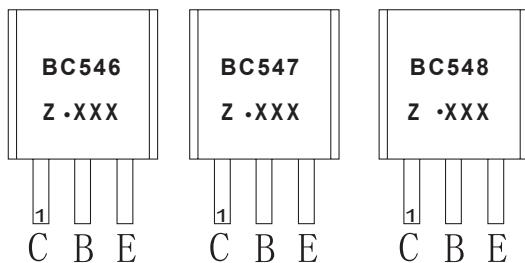


TO-92 Plastic-Encapsulate Transistors

FEATURES

- High Voltage
- Complement to BC556,BC557,BC558

MARKING



BC546,BC547,BC548=Device code

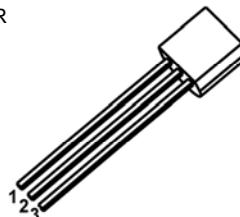
Solid dot=Green molding compound device,
if none,the normal device

Z=Rank of h_{FE}

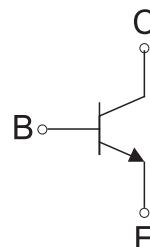
XXX=Code

TO-92

1. COLLECTOR
2. BASE
3. Emitter



Equivalent Circuit



ORDERING INFORMATION

Part Number	Package	Packing Method	Pack Quantity
BC546	TO-92	Bulk	1000pcs/Bag
BC546-TA	TO-92	Tape	2000pcs/Box
BC547	TO-92	Bulk	1000pcs/Bag
BC547-TA	TO-92	Tape	2000pcs/Box
BC548	TO-92	Bulk	1000pcs/Bag
BC548-TA	TO-92	Tape	2000pcs/Box

MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{cbo}	Collector-Base Voltage	BC546	80
		BC547	50
		BC548	30
V_{ceo}	Collector-Emitter Voltage	BC546	65
		BC547	45
		BC548	30
V_{ebo}	Emitter-Base Voltage	BC546	6
		BC547	6
		BC548	5
I_c	Collector Current-Continuous	0.1	A
P_c	Collector Power Dissipation	625	mW
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	200	°C/W
T_j	Junction Temperature	150	°C
T_{stg}	Storage Temperature	-55~+150	°C

ELECTRICAL CHARACTERISTICS

$T_a=25^\circ\text{C}$ unless otherwise specified

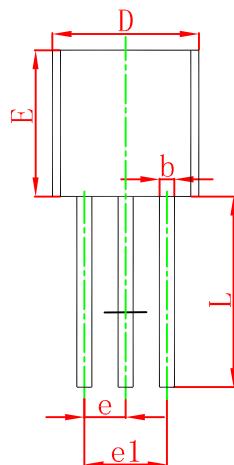
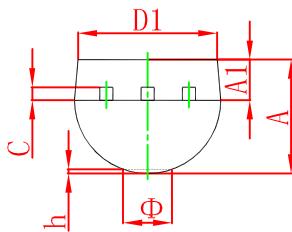
ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	BC546	$V_{(BR)CBO}$	$I_C = 0.1\text{mA}, I_E = 0$	80		
	BC547			50		
	BC548			30		
Collector-emitter breakdown voltage	BC546	$V_{(BR)CEO}$	$I_C = 1\text{mA}, I_B = 0$	65		
	BC547			45		
	BC548			30		
Emitter-base breakdown voltage	BC546	$V_{(BR)EBO}$	$I_E = 10\mu\text{A}, I_C = 0$	6		
	BC547			6		
	BC548			5		
Collector cut-off current	BC546	I_{CEO}	$V_{CB} = 70\text{V}, I_E = 0$		0.1	μA
	BC547		$V_{CB} = 50\text{V}, I_E = 0$		0.1	μA
	BC548		$V_{CB} = 30\text{V}, I_E = 0$		0.1	μA
Collector cut-off current	BC546	I_{CEO}	$V_{CE} = 60\text{V}, I_B = 0$		0.1	μA
	BC547		$V_{CE} = 45\text{V}, I_B = 0$		0.1	μA
	BC548		$V_{CE} = 30\text{V}, I_B = 0$		0.1	μA
Emitter cut-off current	I_{EBO}		$V_{EB} = 5\text{V}, I_C = 0$		0.1	μA
DC current gain	h_{FE}^*		$V_{CE} = 5\text{V}, I_C = 2\text{mA}$	110	800	
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		$I_C = 100\text{mA}, I_B = 5\text{mA}$		0.3	V
Base-emitter saturation voltage	$V_{BE(\text{sat})}$		$I_C = 100\text{mA}, I_B = 5\text{mA}$		1.1	V
Base-emitter voltage	V_{BE}	$V_{CE} = 5\text{V}, I_C = 2\text{mA}$		0.58	0.7	V
		$V_{CE} = 5\text{V}, I_C = 10\text{mA}$			0.75	V
Collector output capacitance	C_{ob}		$V_{CB} = 10\text{V}, I_E = 0, f = 1\text{MHz}$		4.5	pF
Transition frequency	f_T		$V_{CE} = 5\text{V}, I_C = 10\text{mA}, f = 100\text{MHz}$	150		MH

CLASSIFICATION of h_{FE}

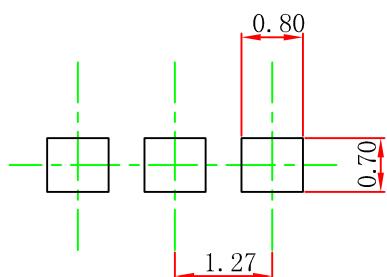
RANK	A	B	C
RANGE	110-220	200-450	420-800

TO-92 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	3.300	3.700	0.130	0.146
A1	1.100	1.400	0.043	0.055
b	0.380	0.550	0.015	0.022
c	0.360	0.510	0.014	0.020
D	4.300	4.700	0.169	0.185
D1	3.430		0.135	
E	4.300	4.700	0.169	0.185
e	1.270 TYP		0.050 TYP	
e1	2.440	2.640	0.096	0.104
L	14.100	14.500	0.555	0.571
Φ		1.600		0.063
h	0.000	0.380	0.000	0.015

TO-92 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.